NCSX RFID	Number: 14-021		RFD Description: Substitution of Chiller		
Part I			riate material		
Initiator: Larry Dudek		Organization: PPPL			
List of Impacted Documents: ( <i>Specification, MIT/QA Plan, SOW, drawing, etc.</i> ) SE142A-252-r0 and SE142A-242-r0					
Cost Impact: (If none, so state): NONE					
Schedule Impact: (If none, so state: NONE – may actually prevent a schedule variance					
Quality Impact: (If none, so state): NONE					
State Requirement Deviation is Requested For: (Specification, MIT/QA Plan, SOW, drawing, etc.): Drawings require UNS alloy C10100 or C10200 copper. This deviation requests the substitution of UNS C11000 ETP copper in a dead soft temper instead.					
Full Description of the Deviation Requested: (Use continuation pages, e-mails, letter, sketches, etc. as needed and include amplifying information as appropriate to support deviation request.)					
The UNS alloy C10100 or C10200 copper which is not readily available and is much more expensive. The vendor can get CDA 110 ETP copper in a dead soft temper from stock which will get us the material much faster and save us the time and trouble of annealing it once we receive it.					
Attachments:					
Initiator Signature	:		Date: May 3, 2006		

NCSX RFD	Number: 14-021		<b>RFD Description:</b> Substitution of Chiller		
IPairt III					
RLM: Wayne Reiersen		Organization: PPPL			
Impact on Interfaces with Other WBS Elements/Items: (If none, so state): NONE					
RLM Recommendation:					
Approve Do Not Approve					
Additional remarks: Formal drawing change not required – impacted drawings will be revised using the "stamp" process outlined in NCSX Procedure PROC-007.					
Although this RFD was written specifically for the Type A Chill Plate material, it should also be applied to the Type B Chill Plate material (drawings not yet developed) since this material is less expensive and has very similar thermal properties.					
Does this Change Impact Material Already Procured or Parts/Assemblies Already Assembled/Manufactured using this Material:					
If "Yes", what is the recommended disposition of this material/part/assembly?					
RLM Signature:					
Project Disposition:					
Approved. No ECP required					
Approved. ECP - assigned and processed.					
<b>Not Approved. Reason(s) for disapproval:</b>					